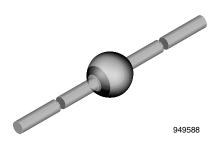


# **Fast Avalanche Sinterglass Diode**



### **MECHANICAL DATA**

Case: SOD-64

Terminals: plated axial leads, solderable per MIL-STD-750,

method 2026

Polarity: color band denotes cathode end

**Mounting position:** any **Weight:** approx. 858 mg

#### **FEATURES**

- · Glass passivated junction
- · Hermetically sealed package
- Low reverse current
- · Soft recovery characteristics
- · Very fast reverse recovery time
- Material categorization:
  For definitions of compliance please see <a href="https://www.vishay.com/doc?99912">www.vishay.com/doc?99912</a>





#### ROHS COMPLIANT HALOGEN FREE

#### **APPLICATIONS**

Ultrafast rectification diode for switching mode power supplies

ORDERING INFORMATION (Example)						
DEVICE NAME	ORDERING CODE	TAPED UNITS	MINIMUM ORDER QUANTITY			
BYW178	BYW178-TR	2500 per 10" tape and reel	12 500			
BYW178	BYW178-TAP	2500 per ammopack	12 500			

PARTS TABLE					
PART	TYPE DIFFERENTIATION	PACKAGE			
BYW178	V <sub>R</sub> = 800 V; I <sub>F(AV)</sub> = 3 A	SOD-64			

<b>ABSOLUTE MAXIMUM RATINGS</b> (T <sub>amb</sub> = 25 °C, unless otherwise specified)						
PARAMETER	TEST CONDITION	PART	SYMBOL	VALUE	UNIT	
Reverse voltage = repetitive peak reverse voltage	See electrical characteristics	BYW178	$V_R = V_{RRM}$	800	V	
Peak forward surge current	t <sub>p</sub> = 10 ms, half sine wave		I <sub>FSM</sub>	80		
Repetitive peak forward current			I <sub>FRM</sub>	15	Α	
Average forward current			I <sub>F(AV)</sub>	3		
Junction and storage temperature range			$T_j = T_{stg}$	- 55 to + 175	°C	
Non repetitive reverse avalanche energy	$I_{(BR)R} = 1 A$		E <sub>R</sub>	20	mJ	

MAXIMUM THERMAL RESISTANCE (T <sub>amb</sub> = 25 °C, unless otherwise specified)						
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT		
Junction lead	Lead length I = 10 mm, T <sub>L</sub> = constant	R <sub>thJL</sub>	25	K/W		
Junction ambient	On PC board with spacing 37.5 mm	R <sub>thJA</sub>	70	K/W		



<b>ELECTRICAL CHARACTERISTICS</b> (T <sub>amb</sub> = 25 °C, unless otherwise specified)							
PARAMETER	TEST CONDITION	PART	SYMBOL	MIN.	TYP.	MAX.	UNIT
Forward voltage	I <sub>F</sub> = 3 A		V <sub>F</sub>	-	-	1.9	V
Reverse current	$V_R = V_{RRM}$		I <sub>R</sub>	-	-	1	μA
neverse current	$V_R = V_{RRM}$ , $T_j = 100  ^{\circ}C$		I <sub>R</sub>	-	-	20	μA
Reverse recovery current	$I_F$ = 1 A, $dI_F/dt \le$ - 50 A/ $\mu$ s, $V_{BATT}$ = 200 V		I <sub>RM</sub>	-	2.2	-	
Reverse recovery time	$I_F = 1 \text{ A}, \ dI_F/dt \le -50 \text{ A/}\mu\text{s}, \ V_{BATT} = 200 \text{ V}, \ i_R = 0.25 \text{ x } I_{RM}$		t <sub>rr</sub>	-	50	-	ns
Reverse recovery time (JEDEC)	$I_F = 0.5 \text{ A}, I_R = 1 \text{ A}, I_R = 0.25$		t <sub>rr</sub>	-	-	60	

### **TYPICAL CHARACTERISTICS** (T<sub>amb</sub> = 25 °C, unless otherwise specified)

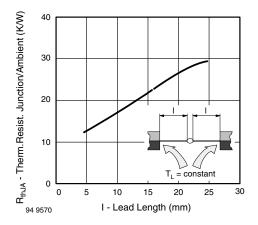


Fig. 1 - Max. Thermal Resistance vs. Lead Length

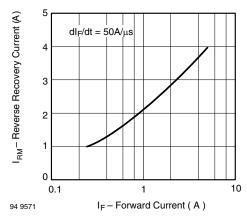


Fig. 2 - Typ. Reverse Recovery Current vs. Forward Voltage

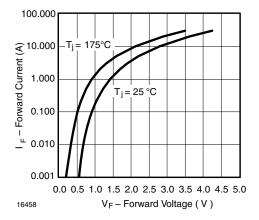


Fig. 3 - Forward Current vs. Forward Voltage

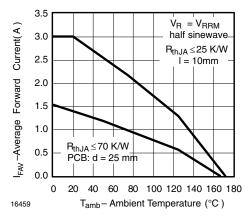


Fig. 4 - Max. Average Forward Current vs. Junction Temperature



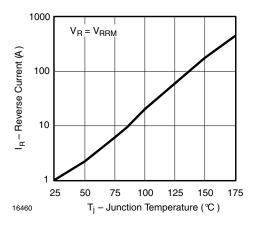


Fig. 5 - Reverse Current vs. Junction Temperature

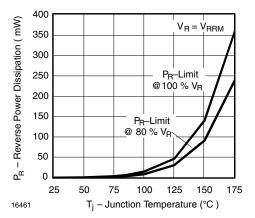


Fig. 6 - Max. Reverse Power Dissipation vs. Junction Temperature

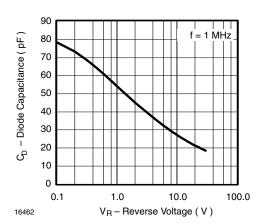


Fig. 7 - Diode Capacitance vs. Reverse Voltage

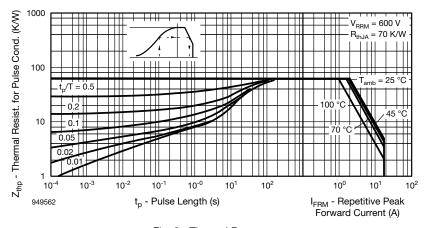
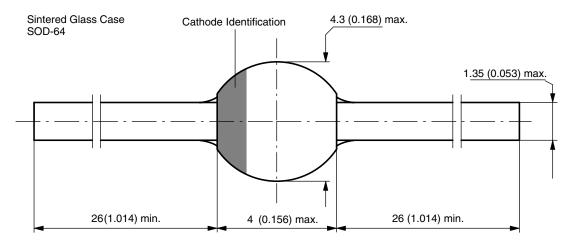


Fig. 8 - Thermal Response

### PACKAGE DIMENSIONS in millimeters (inches): SOD-64



Document-No.: 6.563-5006.4-4 Rev. 3 - Date: 09.February.2005

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